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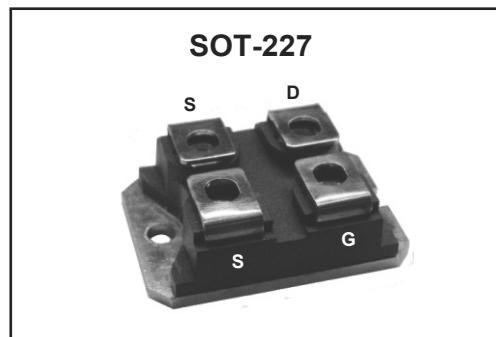
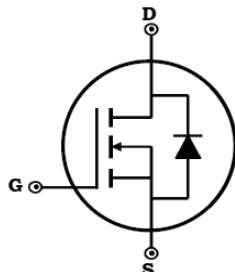
DAMI220N200

N-Channel Enhancement Mode MOSFET

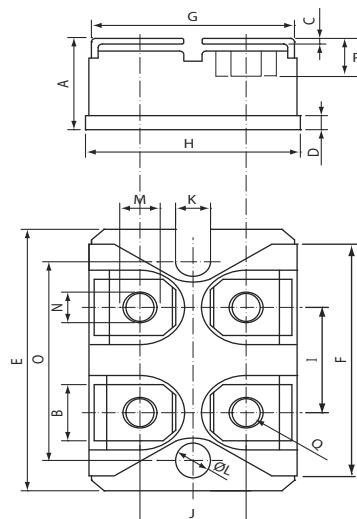
Features

- ◆ $V_{DSS} = 200V$
- ◆ $R_{DS(ON)} < 7.8 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$
- ◆ Fully Avalanche Rated
- ◆ Pb Free & RoHS Compliant
- ◆ Isolation Type Package
- ◆ Electrically Isolation base plate

Preliminary



Dimensions in inches and (millimeters)



Applications

- ◆ Backlighting
- ◆ Power Converters
- ◆ Synchronous Rectifiers

Absolute Maximum Ratings ($T_c=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DS}	200	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous @ $T_c = 25^\circ\text{C}$ @ $T_c = 100^\circ\text{C}$	I_D	220 180	A
Drain Current-Pulsed @ $T_c = 25^\circ\text{C}$ Note ¹	I_{DM}	760	A
Maximum Power Dissipation	P_D	560	W
Storage Temperature Range	T_{STG}	-50 to +150	°C
Operating Junction Temperature Range	T_J	-50 to +150	°C
Thermal Resistance, Junction-to-Case	$R_{\theta_{JC}}$	0.20	°C/W
Isolation Voltage (A.C. 1 minute)	V_{iso}	2500	V
Mounting torque (M4 Screw)	M_d	1.3	N _m

DIM	DIMENSIONS			
	INCHES		MM	
A	.500	.519	12.70	13.60
B	.307	.322	7.80	8.20
C	.029	.033	.75	.84
D	.073	.082	1.85	2.10
E	1.487	1.502	37.80	38.20
F	1.250	1.258	31.75	32.00
G	.931	.956	23.65	24.30
H	.996	1.007	25.30	25.60
I	.586	.594	14.90	15.10
J	.492	.516	12.50	13.10
K	.161	.169	4.10	4.30
L	.161	.169	4.10	4.30
M	.181	.191	4.60	4.95
N	.165	.177	4.20	4.50
O	1.184	1.192	30.10	30.30
P	.217	.244	5.50	6.20
Q	M4*8			



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DAMI220N200

Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

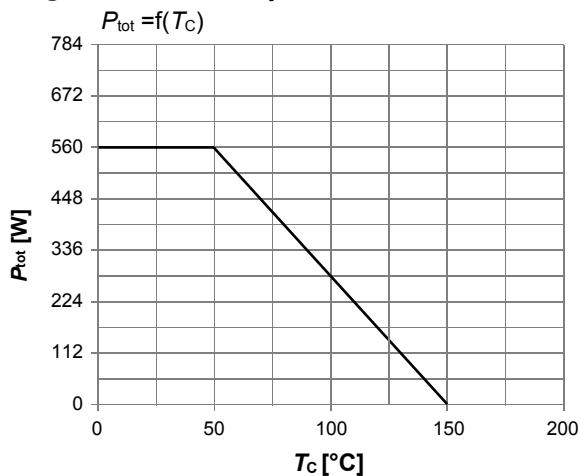
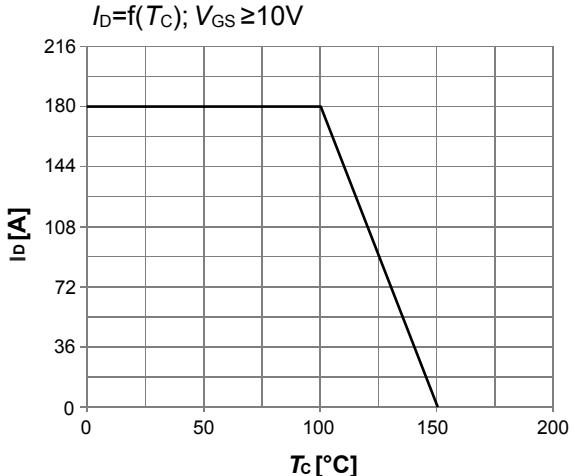
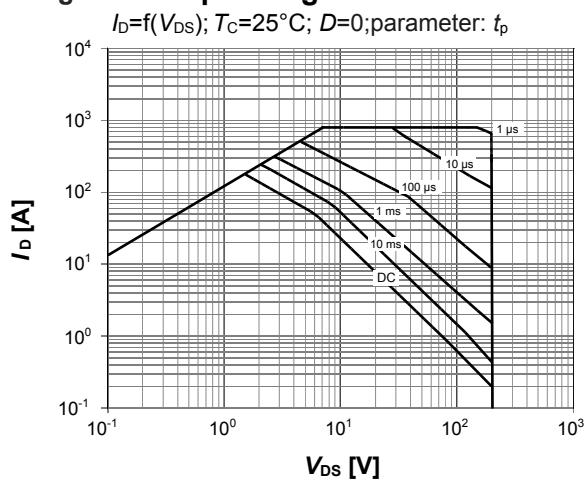
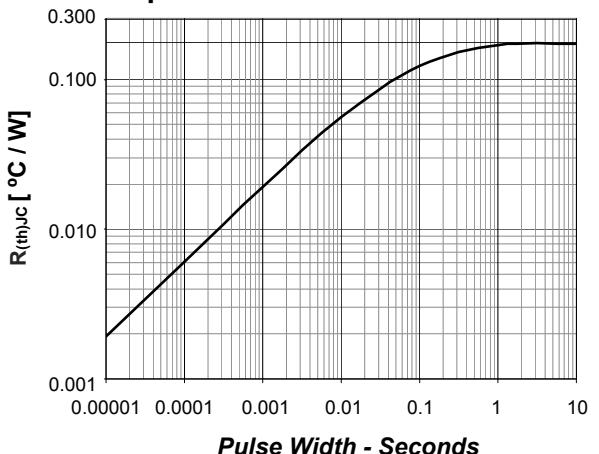
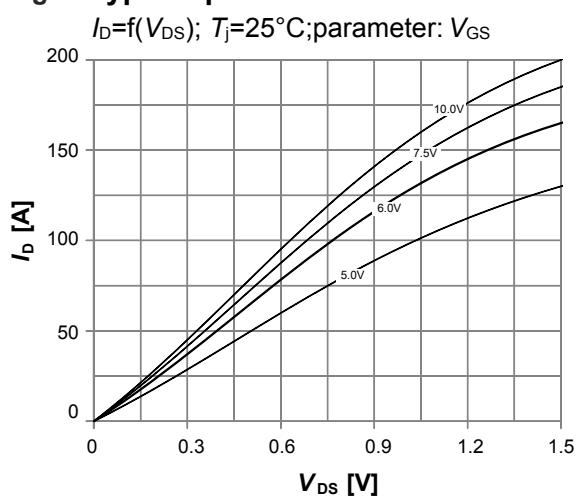
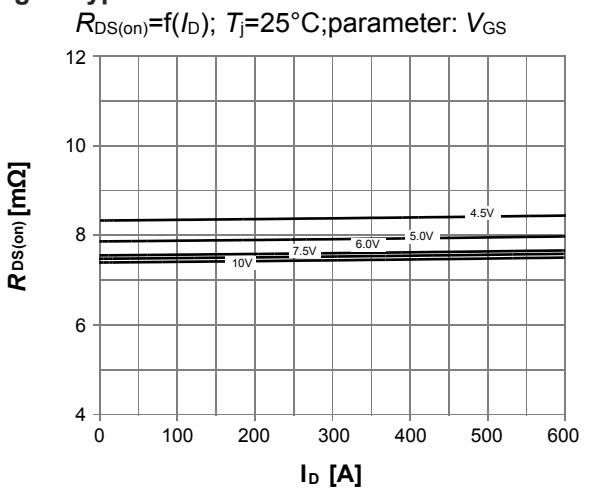
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	
OFF Characteristics							
Drain-Source Breakdown Voltage	BV_{DSS}	$\text{V}_{\text{GS}}=0\text{V}$, $\text{I}_{\text{DS}}=3\text{mA}$	200	-	-	V	
Zero Gate Voltage Drain Current	I_{DSS}	$\text{V}_{\text{GS}}=0\text{V}$, $\text{V}_{\text{DS}}=200\text{V}$	-	-	50	uA	
Gate-Body Leakage	I_{GSS}	$\text{V}_{\text{GS}}=\pm 20\text{V}$, $\text{V}_{\text{DS}}=0\text{V}$	-	-	200	nA	
ON Characteristics							
Gate Threshold Voltage	V_{TH}	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}$, $\text{I}_{\text{DS}}=8\text{mA}$	2.0	2.5	3.5	V	
Drain-Source On-State Resistance	$\text{R}_{\text{DS(on)}}$	$\text{V}_{\text{GS}}=10\text{V}$, $\text{I}_{\text{DS}}=100\text{A}$	-	7.5	7.8	mΩ	
Gate Resistance	R_G		-	1.6	2.9	Ω	
Forward Transconductance	g_{fs}	$ \text{V}_{\text{DS}} > 2 \text{I}_{\text{D}} \text{R}_{\text{DS(on)M}}$, $\text{I}_{\text{D}} = 100\text{A}$	Note1 - 120	-	-	S	
Dynamic Characteristics							
Input Capacitance	C_{iss}	$\text{V}_{\text{DS}}=25\text{V}$		46680	-	pF	
Output Capacitance	C_{oss}	$\text{V}_{\text{GS}}=0\text{V}$		993	-		
Reverse Transfer Capacitance	C_{rss}	Freq.=1MHz		586	-		
Switching Characteristics							
Turn-On Delay Time	$t_{\text{d(on)}}$	$\text{V}_{\text{DD}}=75\text{V}$	-	112	-	ns	
Rise Time	t_r	$\text{V}_{\text{GS}}=10\text{V}$	-	44	-		
Turn-Off Delay Time	$t_{\text{d(off)}}$	$\text{I}_{\text{DS}}=150\text{A}$	-	248	-		
Fall Time	t_f	$\text{R}_G=1.6\Omega$	-	48	-		
Total Gate Charge at 10V	Q_g	$\text{V}_{\text{DS}}=10\text{V}$	-	335	-	nC	
Gate to Source Charge	Q_{gs}	$\text{V}_{\text{GS}}=10\text{V}$	-	188	-		
Gate to Drain Charge	Q_{gd}	$\text{I}_{\text{DS}}=100\text{A}$	-	115	-		
Reverse Diode Characteristics							
Drain-Source Diode Forward Voltage	V_F	$\text{T}_J=25^\circ\text{C}$, $\text{I}_F=100\text{A}$	-	-	0.85	V	
Diode Continuous Forward Current	I_F		-	-	180	A	
Diode Pulsed Current Note1	$\text{I}_{\text{F,pulse}}$		-	-	760	A	
Reverse Recovery time	T_{RR}	$\text{I}_F=0.5\text{V}$, $\text{I}_R=1.0\text{A}$, $\text{I}_{\text{RR}}=0.25\text{A}$	-	-	300	ns	

Notes:

1. Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $> 2\%$.



Typical Characteristics

Fig 1. Power dissipation**Fig 2. Drain current****Fig 3. Safe operating area****Fig 4. Maximum Transient Thermal Impedance****Fig 5. Typ. output characteristics****Fig 6. Typ. drain-source on resistance**



Typical Characteristics

Fig 7. Typ. transfer characteristics

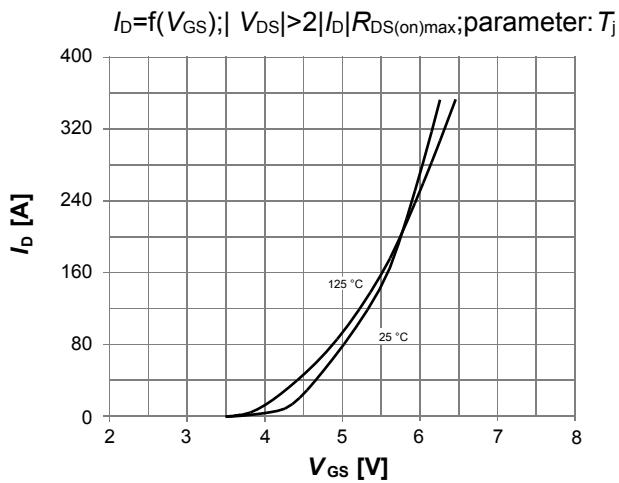


Fig 9. Drain-source on-state resistance

$R_{DS(on)}=f(T_j)$; $I_D=150\text{ A}$; $V_{GS}=10\text{ V}$

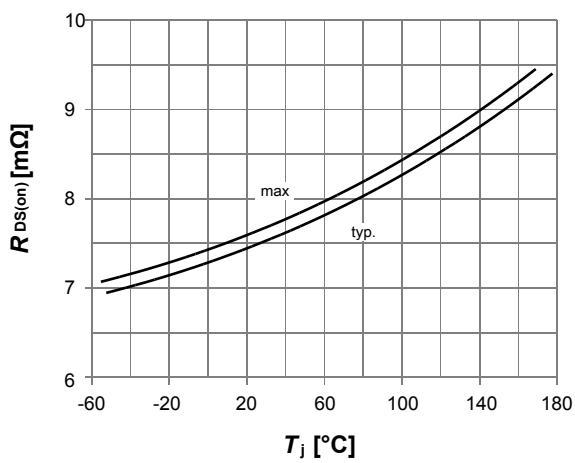


Fig 11. Typ. capacitances

$C=f(V_{DS})$; $V_{GS}=0\text{ V}$; $f=1\text{ MHz}$

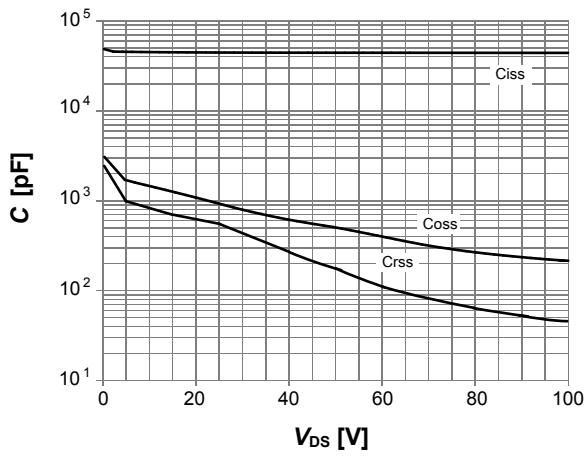


Fig 8. Typ. forward transconductance

$g_{fs}=f(I_D)$; $T_j=25^\circ\text{C}$

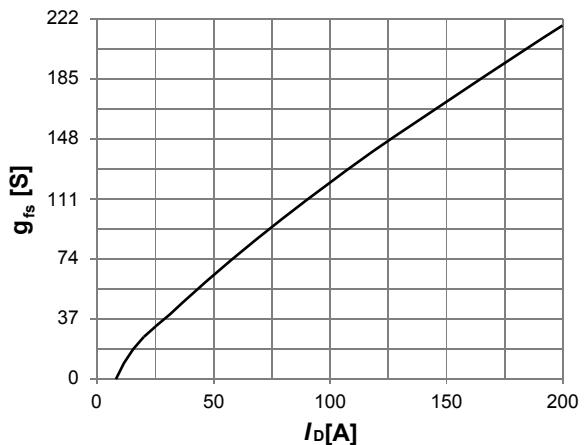


Fig 10. Typ. gate threshold voltage

$V_{GS(th)}=f(T_j)$; $V_{GS}=V_{DS}$; parameter: I_D

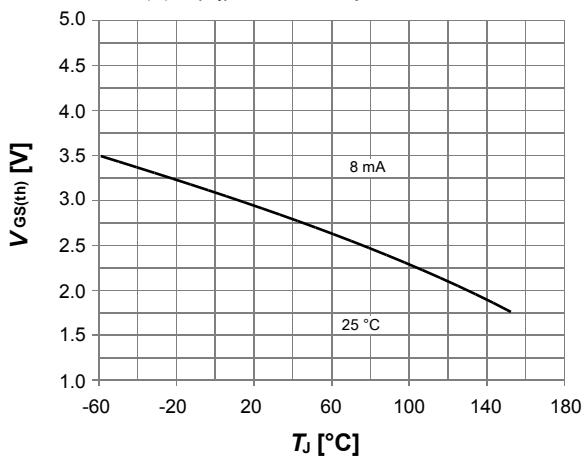
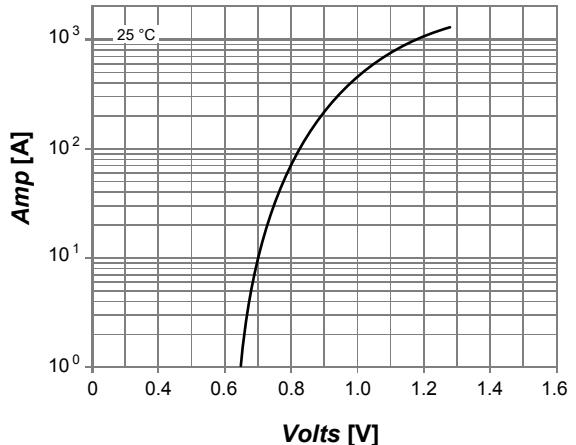


Fig 12. Typical forward characteristics of reverse diode





Typical Characteristics

Fig 13. Forward derating curve of reverse diode

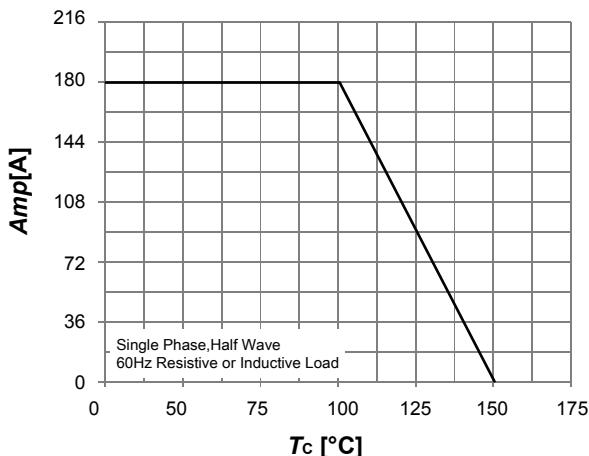


Fig 14. Peak forward surge current of reverse diode

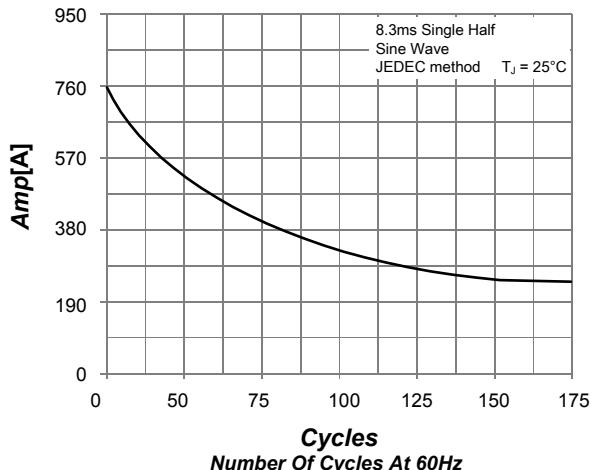


Fig 15. Typical reverse diode characteristics

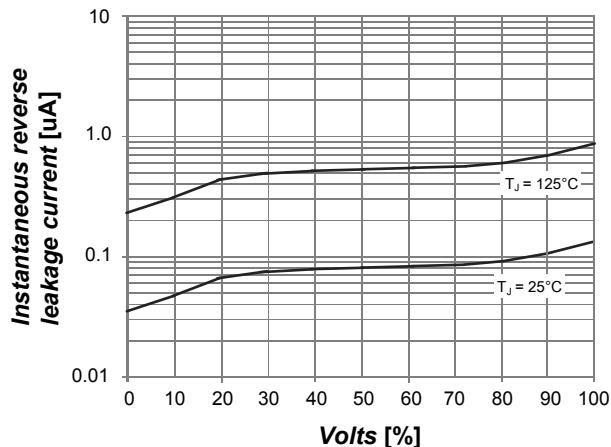


Fig 16. Typ. gate charge

$V_{GS} = f(Q_{gate})$; $I_D = 100$ A pulsed; parameter: V_{DD}

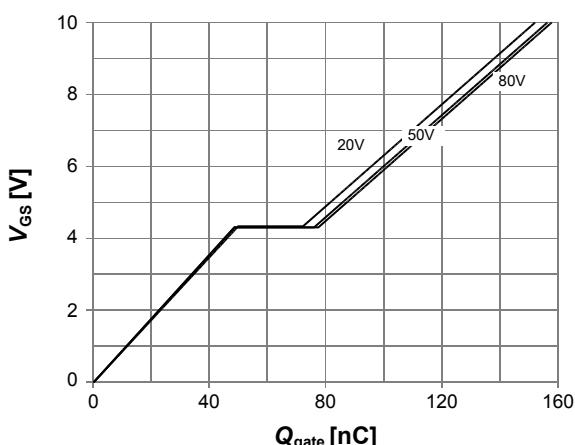
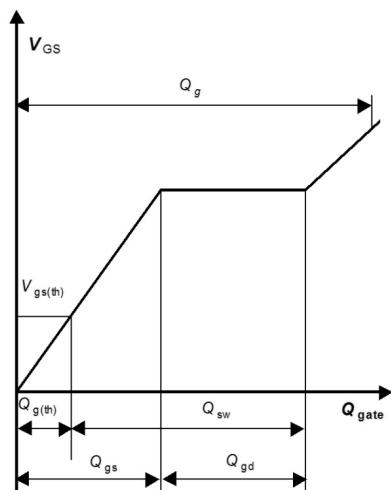


Fig 17. Gate charge waveforms



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